

# VRF250DV2 - BD



## W-Band 93-95GHz GaAs MMIC Low Power Amplifier

Preliminary Datasheet v2

### Features

- Frequency Range: 93 to 95GHz
- Saturated Output Power 17.5dBm CW typical
- Small Signal Gain 18dB
- Bias:  $V_d = 4V$
- Die Size: 2.5mm x 1.5mm x 0.05 mm



### Description

The VRF250DV2-BD is a GaAs MMIC driver amplifier which operates over the frequency range of 93 to 95GHz. The amplifier typically delivers a small signal gain of +18dB, output power P1dB of +17.5dBm CW typical. The RF ports are DC blocked and matched to 50Ω. Typical applications for the VRF250DV2-BD include radar and Test and Instrumentation.

### Electrical Specifications

$T = +25^{\circ}C$  baseplate,  $V_{DD} = +4V$

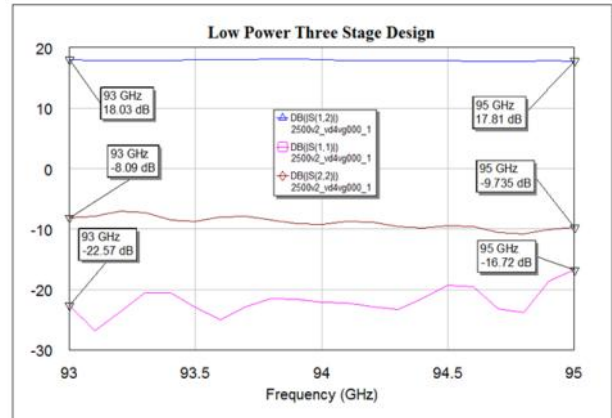
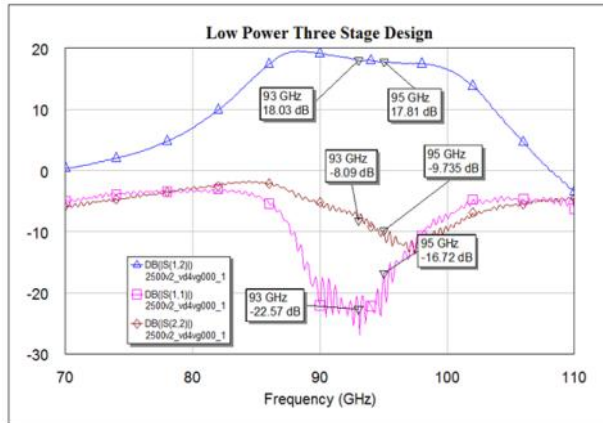
Parameter	Specification			Unit
	Max.	Typ.	Min.	
Frequency Bandwidth	93		95	GHz
Small Signal Gain		18		dB
Output power for 1dB Compression (P1dB)		16		dBm
Saturated Output Power (Psat)		17.5		dBm
I/P Return Loss		-8		dB
O/P Return Loss		-15		dB

## W-Band 93-95GHz GaAs MMIC Low Power Amplifier

Preliminary Datasheet v2

### Measured Performance (on wafer)

$T=+25^{\circ}\text{C}$  baseplate,  $V_{DD} = +4\text{V}$



### Recommended Absolute Maximum Ratings <sup>[1]</sup>

Parameter	Symbol	Value	Notes
Drain Bias Voltage	$V_d$	+8V	
Gate Bias Voltage	$V_g$	-5V	
Gate Current	$I_g$	5mA	
RF input power	$RF_{in}$	+5dBm	
Power Dissipation	$P_d$		Related to Junction Temperature
Junction Temperature	$T_j$	200°C	For maximum median device lifetime, $T_j$ should be minimised
Storage Temperature	$T_{storage}$	-55 to 150°C	

<sup>[1]</sup> Operation outside these conditions may cause permanent damage to the device. Combination of maximum rating conditions may reduce the values. Device performance at these ratings is not implied.

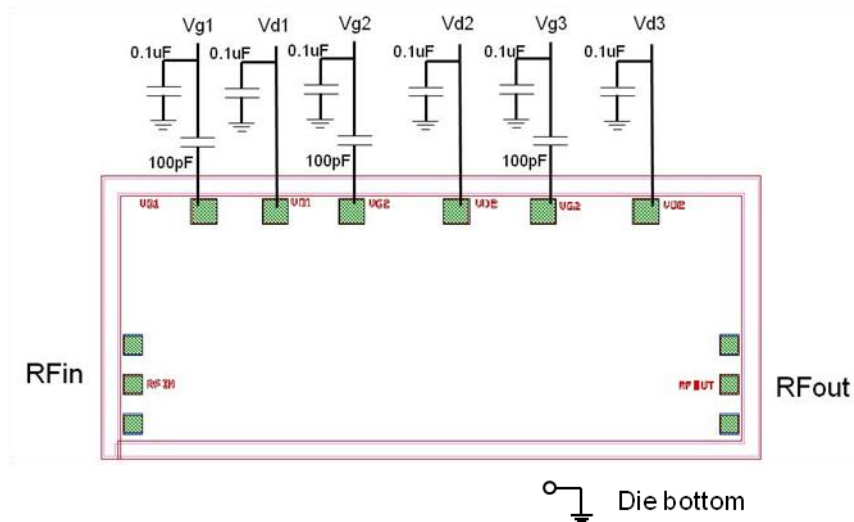
# VRF250DV2 - BD



## W-Band 93-95GHz GaAs MMIC Low Power Amplifier

Preliminary Datasheet v2

### Assembly & Bonding Diagram



Die Size	2.5mm x 1.5mm
Die Thickness	50µm
Minimum Bondpad opening	70µm x 70µm

Minimal length (0.15nH) are recommended for RF bondwires. The RF input and output ports are DC blocked.

GaAs devices are ESD sensitive and precautions should be observed during storage, handling, assembly and testing.

